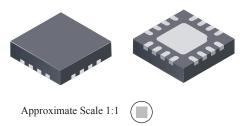


#### Features and Benefits

- Wide battery voltage range: 1.5 to 11 V
- Integrated 55 V DMOS switch with 3.2 A current capability
- User-adjustable peak current limit, from 1 to 3.2 A
- Secondary-side voltage sensing for easily-adjustable output voltage
- >75% efficiency
- Fast charging time
- Charge complete indication
- Flexible, high current IGBT driver
  Independent IGBT driver supply
- $\circ$  Separate sink and source pins with 6  $\Omega$  pull-up and 20  $\Omega$  pull-down
- Interlocked trigger pins improve noise immunity
- No primary-side Schottky diode needed

### Package: 16-contact TQFN (suffix ES)



#### Description

The A8426 is a highly integrated IC that rapidly charges photoflash capacitors for SLR cameras, digital cameras, and camcorders with integrated digital cameras. A flexible IGBT driver is integrated to save board space.

The A8426 integrates a 3.2 A-capable, 55 V-rated DMOS switch that drives the transformer in flyback configuration, allowing optimized design with tight coupling and high efficiency. The peak switch current is user-adjustable between 1 and 3.2 A, using a resistor to ground. A proprietary control scheme optimizes the capacitor charging time. Low quiescent current and low-power Standby mode current further improve system efficiency and extend battery life.

The A8426 is available in a 16-contact 3 mm  $\times$  3 mm TQFN package with exposed pad for enhanced thermal performance. This small, very thin profile (0.75 mm nominal overall height) package is ideal for space-constrained applications. It is lead (Pb) free, with 100% matte-tin leadframe plating.

Applications include:

- SLR camera flash
- Digital camcorder/DSC combo flash
- 2 Li+ input strobe

### **Typical Application**

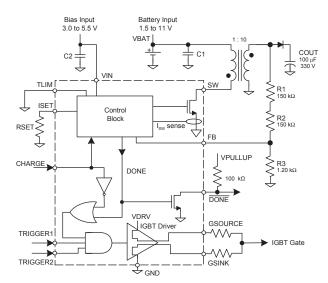


Figure 1. Typical application circuit with resistor bridge control of feedback.

#### **Selection Guide**

Part Number	Packing*	
A8426EESTR-T	Tape and reel, 1500 pieces/reel	
*O ante et Alle and for a delitional a delition anti-		

\*Contact Allegro for additional packing options.



#### **Absolute Maximum Ratings**

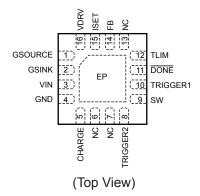
Characteristic	Symbol	Notes	Rating	Units
SW Pin	V <sub>SW</sub>		-0.3 to 55	V
VIN Pin	V <sub>IN</sub>		–0.3 to 7	V
Remaining Pins			–0.3 to V <sub>IN</sub> + 0.3 V	V
Operating Ambient Temperature	T <sub>A</sub>	Range E	-40 to 85	°C
Maximum Junction	T <sub>J</sub> (max)		150	°C
Storage Temperature	T <sub>stg</sub>		-55 to 150	°C

Characteristic	Symbol	Test Conditions*	Value	Units
Package Thermal Resistance	$R_{\thetaJA}$	On 4-layer PCB based on JEDEC standard	47	°C/W

\*Additional thermal information available on Allegro website.



#### Pin-out Diagram



#### **Terminal List Table**

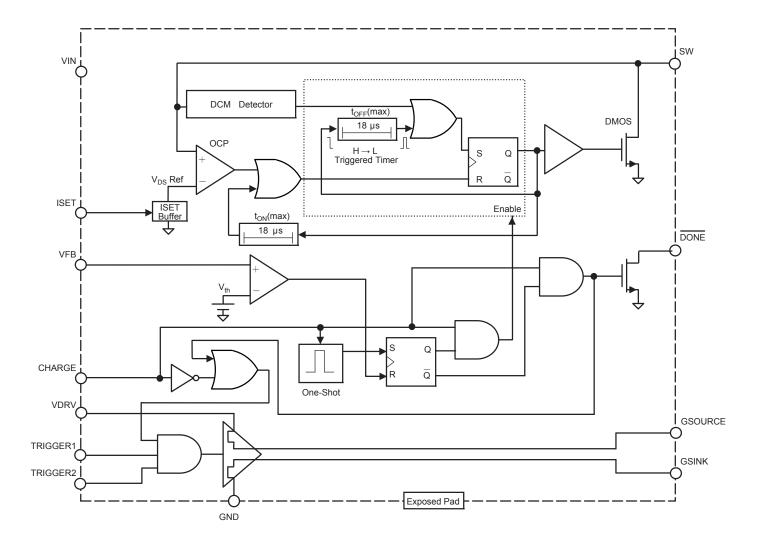
Number	Name	Function
1	GSOURCE	IGBT gate drive – source connection
2	GSINK	IGBT gate drive – sink connection
3	VIN	IC bias input, connect to a 3.0 to 5.5 V supply; for single Li+ battery applications this pin may be connected to the battery with sufficient decoupling
4	GND	Ground connection
5	CHARGE	Pull high to initiate charging; pull low to enter low-power standby mode
6, 7, 13	NC	No connection
8	TRIGGER2	IGBT input trigger 2; internally ANDed with TRIGGER1 pin
9	SW	Swtich pin; drain connection of internal power DMOSFET switch
10	TRIGGER1	IGBT input trigger 1; internally ANDed with TRIGGER2 pin
11	DONE	Open drain pin; indicates charge complete when pulled low by internal MOSFET
12	TLIM	For production test only; connect to GND on PCB
14	FB	Output feedback
15	ISET	Sets the maximum switch current; connect an external resistor to GND to set the target peak current
16	VDRV	Supply for IGBT gate driver
_	EP	Exposed pad for enhanced thermal dissipation



A8426

# High Performance Photoflash Capacitor Charger with IGBT Driver

#### **Functional Block Diagram**





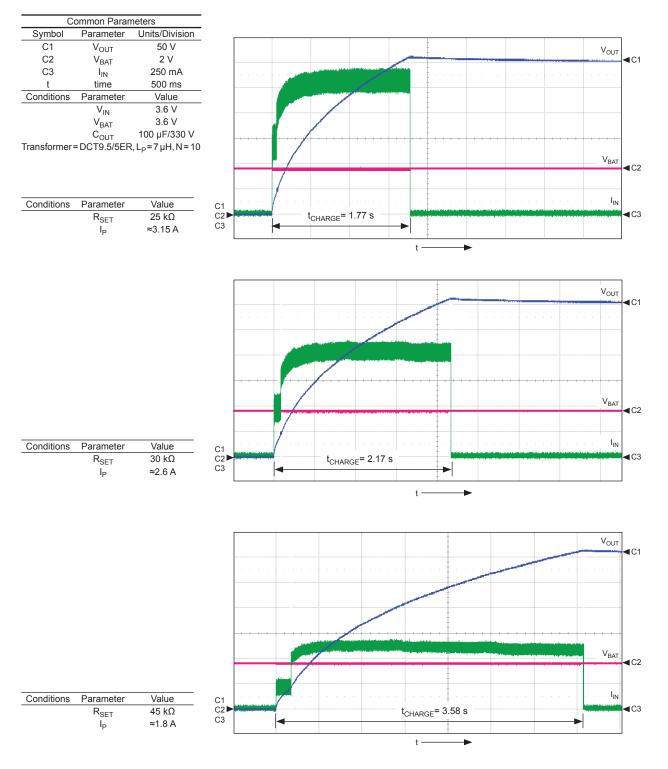
Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
VBAT Pin Voltage Range <sup>1</sup>	V <sub>BAT</sub>		1.5	-	11	V
VIN Pin Voltage Range <sup>1</sup>	V <sub>IN</sub>		3.0	_	5.5	V
UVLO Enable Threshold	V <sub>INUV</sub>	V <sub>IN</sub> rising	2.55	2.65	2.75	V
UVLO Hysteresis	V <sub>INUVhys</sub>		-	150	_	mV
Qualitate Quantant Lingth?	ISWIimMAX	Maximum, R <sub>SET</sub> = 21.8 kΩ	2.9	3.2	3.5	A
Switch Current Limit <sup>2</sup>	I <sub>SWlimMIN</sub>	Minimum, R <sub>SET</sub> = 72 kΩ	-	1.0	_	Α
SW Current Limit to ISET Current Ratio	I <sub>SWlim</sub> /I <sub>SET</sub>	$R_{SET}$ = 21.8 kΩ, CHARGE = high	-	58.5	-	kA/A
ISET Pin Voltage While Charging	V <sub>SET</sub>	$R_{SET}$ = 35 kΩ, CHARGE = high	-	1.2	-	V
ISET Pin Internal Resistance	R <sub>SET(INT)</sub>		_	330	_	Ω
Switch On-Resistance	R <sub>SWDS(on)</sub>	V <sub>IN</sub> = 3.6 V, I <sub>D</sub> = 800 mA, T <sub>A</sub> = 25°C	_	0.2	_	Ω
Switch Leakage Current <sup>1</sup>	I <sub>SWIk</sub>	V <sub>SW</sub> = V <sub>BAT</sub> (max), in shutdown	-	-	1	μA
		Shutdown (CHARGE = low, TRIGGER = low)	-	0.01	1	μA
VIN Pin Supply Current	I <sub>VIN</sub>	Charging done (CHARGE = high, DONE = low)	-	25	100	μA
		Charging (CHARGE = high, TRIGGER = low)	-	2	-	mA
CHARGE Pin Input Current	I <sub>CHARGE</sub>	CHARGE = V <sub>IN</sub>	-	36	-	μA
CHARGE Pin Input Voltage High <sup>1</sup>	I <sub>CHARGE(H)</sub>	Over input supply range, V <sub>IN</sub>	1.4	-	_	V
CHARGE Pin Input Voltage Low <sup>1</sup>	I <sub>CHARGE(L)</sub>	Over input supply range, V <sub>IN</sub>	_	_	0.4	V
CHARGE Pin Pull-down Resistor	R <sub>CHARGE</sub>		-	100	-	kΩ
Maximum Switch-off Timeout	t <sub>offMAX</sub>		-	18	-	μs
Maximum Switch-on Timeout	t <sub>onMAX</sub>		-	18	-	μs
DONE Pin Output Leakage Current <sup>1</sup>	IDONEIK		-	-	1	μA
DONE Pin Output Low Voltage <sup>1</sup>	V <sub>DONEL</sub>	32 µA into DONE pin	-	_	100	mV
FB Threshold <sup>1</sup>	V <sub>FBth</sub>		1.187	1.205	1.223	V
FB Input Current	I <sub>FB</sub>	V <sub>FB</sub> = 0 V to VIN	-	12	-	nA
Minimum dV/dt for ZVS Comparator	dV/dt	Measured at SW pin	-	20	-	V/µs
IGBT Driver						
VDRV Pin Supply Voltage (for IGBT Driver) <sup>1</sup>	V <sub>DRV</sub>		3	-	5.5	V
TRIGGERx Pins Input Current	I <sub>TRIG</sub>	V <sub>TRIGGER</sub> = VIN	-	36	_	μA
TRIGGERx Pins High Input Voltage <sup>1</sup>	V <sub>TRIG(H)</sub>	Over input supply range, V <sub>IN</sub>	1.4	-	-	V
TRIGGERx Pins Low Input Voltage <sup>1</sup>	V <sub>TRIG(L)</sub>	Over input supply range, V <sub>IN</sub>	-	-	0.4	V
TRIGGERx Pins Pull-down Resistor	R <sub>TRIGPD</sub>		_	100	-	kΩ
GSOURCE On-Resistance to VDRV	R <sub>SrcDS(on)</sub>	V <sub>DRV</sub> = 3.6 V, V <sub>GSOURCE</sub> = 1.8 V	-	6	_	Ω
GSINK On-Resistance to GND	R <sub>SnkDS(on)</sub>	V <sub>DRV</sub> = 3.6 V, V <sub>GSINK</sub> = 1.8 V	-	20	-	Ω
Propagation Delay (Rising)	t <sub>dr</sub>		-	30	-	ns
Propagation Delay (Falling)	t <sub>df</sub>	Connect GSOURCE to GSINK, $R_{GATE} = 12 \Omega$ ,	-	140	_	ns
Output Rise Time	t <sub>r</sub>	$C_{\text{LOAD}}$ = 6500 pF, $V_{\text{DRV}}$ = 3.6 V		80	-	ns
Output Fall Time	t <sub>f</sub>			320	_	ns

<sup>1</sup>Specifications over the range  $T_A$ = –40°C to 85°C; guaranteed by design and characterization. <sup>2</sup>Current limit guaranteed by design and correlation to static test. Refer to Application Information section for peak current in actual circuits.

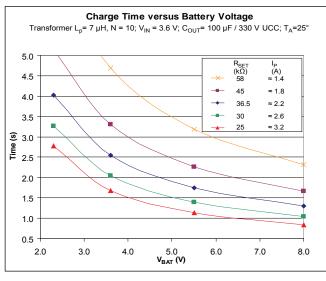


### **Performance Characteristics**

Charging Time at Various Peak Current Levels

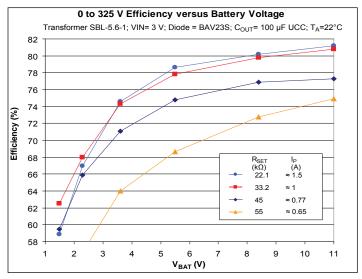




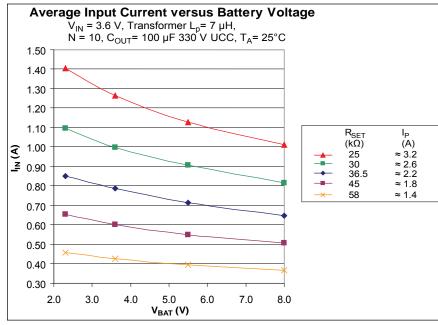


### Performance Characteristics

 $C_{OUT}$ = 100 µF. For larger or smaller capacitances, charging time scales proportionally.



This data was obtained using a Kijima-Musen SBL-5.6-1 transformer ( $L_p = 9.8 \mu$ H, N = 10.2). Highest efficiency is achieved at high battery voltage and large peak current (1 to 1.5 A). At lower current (< 1 A), switching frequency increases and so do switching losses. Therefore a transformer with higher primary inductance is preferred when operating at lower current.

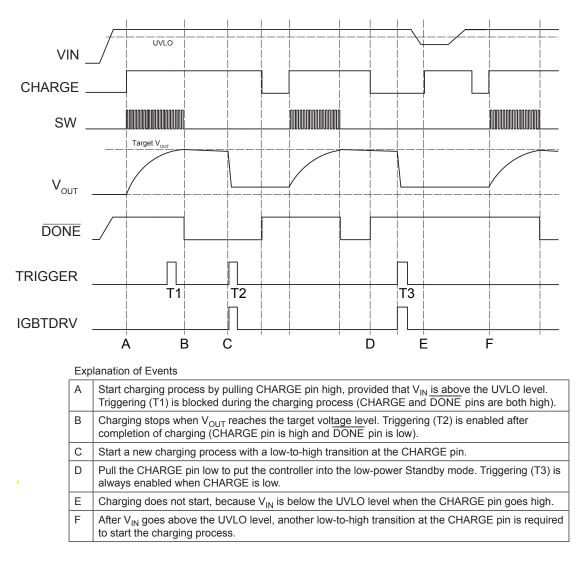


The average input current decreases with higher V<sub>BAT</sub>.

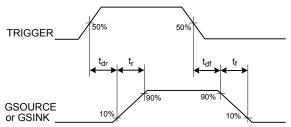


#### **Timing and IGBT Interlock Function**

The two TRIGGER signals are internally ANDed together. As shown in the timing diagram, below, triggering is prohibited during the initial charging process. This prevents premature firing of the flash before the output capacitor has been charged to its target voltage. Refer to the section IGBT Gate Driver Interlock for details.



### **IGBT Drive Timing Definition**





### **Application Information**

### **Circuit Description**

The A8426 is a photoflash capacitor charger control IC with a high current limit (up to 3.2 A) and low  $R_{DS(on)}$  (0.23  $\Omega$  maximum). The IC also integrates an IGBT driver for strobe operation of the flash, dramatically saving board space in comparison with discrete solutions for strobe flash operation.

The IC is turned on by a low-to-high signal on the CHARGE pin, provided that  $V_{IN}$  is above the UVLO level. Note that if CHARGE is already high before V<sub>IN</sub> reaches the UVLO threshold, charging will not start until CHARGE goes through another low-to-high transition. When the charging cycle is initiated, the primary current ramps up linearly at a rate determined by the battery voltage and the primary side inductan ce. When the primary current reaches the set limit, the internal MOSFET is turned off immediately to allow the energy to be dumped into the photoflash capacitor through the secondary winding. The secondary current drops linearly as the output capacitor is charged. The charging cycle starts again when the transformer flux is reset or after a predetermined time period (18 µs maximum off-time) has passed, whichever occurs first.

### Target Output Voltage

Output voltage sensing is done using a resistor divider network (see figure 1: R1, R2 and R3) on the secondary side of the transformer. The target output voltage is determined by the ratio of the voltage divider:

$$(R_1 + R_2 + R_3)/R_3 = (V_{\text{OUT}} + V_d)/V_{\text{FB}},$$
 (1)

where  $V_d$  is the diode voltage drop (typically 1 to 2 V). R1 and R2 together must have a breakdown voltage of at least 300 V. A typical type 1206 surface mount resistor has a 150 V breakdown voltage rating. It is recommended that R1 and R2 have similar values to ensure an even voltage stress between them. Recommended values are:

 $R_1 = R_2 = 150 \text{ k}\Omega$  (type 1206), and

 $R_3 = 1.20 \text{ k}\Omega \text{ (type 0603)},$ 

which together yield a target voltage of 300 V.

Using higher resistance ratings for R1, R2, and R3 does not offer significant efficiency improvement, because the power loss of the feedback network occurs mainly during switch off-time, and off-time is only a small fraction of each charging cycle. Furthermore, if values of R1 and R2 are too high, effects of parasitic capacitance from the sensing network to GND may affect the accuracy of the target voltage.

When the designated output voltage is reached, the A8426 stops the charging until the CHARGE pin is toggled again. Alternatively, pulling the CHARGE pin low also stops the charging. The DONE pin is an open-drain indicator of when the designated output is reached. Pulling the CHARGE pin low puts the A8426 into the low-current Standby mode and it forces the DONE pin into a high impedence mode, irrespective of the output voltage.

### Switch Current Limiting

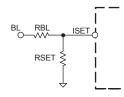
The peak switch current limit is determined by a resistor, RSET, connected between the ISET pin and GND. The value of RSET can be between 22 and 72 k $\Omega$ . This generates an ISET current between 17 and 55  $\mu$ A, which corresponds to a desired peak switch current in a range from 1 to 3.2 A.

### Smart Current Limit (Optional)

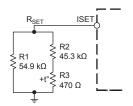
With the help of some simple external logic, the user can change the charging current according to the battery voltage. For example, assume that  $I_{SET}$  is normally 50  $\mu$ A (for  $I_{SWlim}$  = 2.75 A). Referring to the



following illustration, when the battery voltage drops below 2.5 V, the signal at BL (battery-low) should go high. The resistor RBL, connecting BL to the ISET pin, then injects 20  $\mu$ A into RSET. This effectively reduces ISET current to 30  $\mu$ A (for I<sub>SWLIM</sub> = 1.65 A). The disadvantage of this method is that 20  $\mu$ A flows continuously while BL is high.



In another example of a possible application, we can make use of a PTC thermistor to decrease the switch current limit when the board temperature exceeds 65°C. Refering to the following figure, R3 is a PTC type thermistor such as the Murata PRF18BG471QB1RB.



In this configuration, the peak currents at various PCB temperatures are as follows:

T <sub>PCB</sub> (°C)	R <sub>3</sub> (kΩ)	R <sub>SET</sub> (kΩ)	I <sub>SWpeak</sub> (A)
25	0.470	25.0	3.2
65	4.7	26.2	3.0
80	47.0	34.4	2.3

### Selection of Transformer

1. The primary inductance,  $L_P$ , determines the on-time of the switch, as follows:

$$t_{\rm on} = -L_{\rm P}/R \times \ln\left(1 - I_{\rm SWlim} \times R/V_{\rm BAT}\right), \quad (2)$$

where R is the total resistance in the primary current path (including  $R_{SWDS(on)}$  and the DC resistance of the transformer).

If  $V_{BAT}$  is much larger than  $I_{SWlim} \times R$ , then  $t_{on}$  can be approximated using the following formula:

$$t_{\rm on} = I_{\rm SWlim} \times L_{\rm P} / V_{\rm BAT} \,. \tag{3}$$

2. The secondary inductance,  $L_S$ , determines the offtime of the switch, as follows:

$$t_{\rm off} = (I_{\rm SWlim}/N) \times L_{\rm S}/V_{\rm OUT} \,. \tag{4}$$

Because  $L_S/L_P = N \times N$ :

$$t_{\rm off} = (I_{\rm SWlim} \times L_{\rm P} \times N) / V_{\rm OUT} \,. \tag{5}$$

The minimum pulse width for  $t_{off}$  determines the minimum primary inductance required for the transformer. For example, if  $I_{SWlim} = 1.0$  A, N = 10, and  $V_{OUT} = 315$  V, then  $L_P$  must be at least 6.3 µH in order to keep  $t_{off}$  at 200 ns or longer. In general, choosing a transformer with larger  $L_P$  results in higher efficiency (because the higher the value of  $L_P$ , the lower the switch frequency, and hence the lower the switching loss). But transformers with higher  $L_P$  ratings also require more windings and larger magnetic cores. Therefore a trade-off must be made between transformer size and efficiency.



### Selection of Switching Current Limit

The A8426 features continuously adjustable peak switching current between 1.0 and 3.2 A. This is done by selecting the value of the external resistor RSET (connected between the ISET pin and GND), which determines the ISET bias current, and therefore the switching current limit, I<sub>SWlim</sub>.

To the first order approximation,  $I_{SWlim}$  is related to  $I_{SET}$  and  $R_{SET}$  by the following equation:

$$I_{\text{SWlim}} = I_{\text{SET}} \times K$$
$$= (V_{\text{SET}} \times R_{\text{SET}}) \times K , \qquad (6)$$

where K  $\approx$  60000 when the IC bias voltage, V<sub>IN</sub>, is 3.6 V.

In real applications, the switching current limit is affected by bias voltage, battery voltage, and the transformer primary inductance,  $L_P$ . If necessary, the following expressions can be used to determine  $I_{SWlim}$  more accurately:

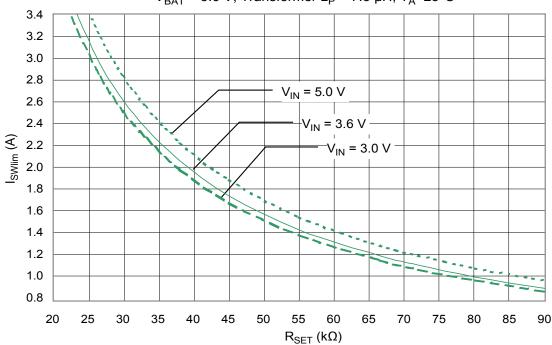
$$I_{\text{SET}} = V_{\text{SET}} / (R_{\text{SET}} + R_{\text{SET(INT)}} - K \times R_{\text{G(INT)}}), (7)$$

where  $R_{SET(INT)}$  is the internal resistance of the ISET pin (330  $\Omega$  typical),  $R_{G(INT)}$  is the internal resistance of the bonding wire for the GND pin (27 m $\Omega$  typical), and:

$$I_{\text{SWlim}} = I_{\text{SET}} \times (\text{K}' + V_{\text{IN}} \times \text{K}'') + (V_{\text{BAT}} / L_{\text{P}}) \times t_{\text{d}} , \qquad (8)$$

where K' = 47500, K'' = 3500, and  $t_d = delay$  in SW turn-off (0.12 µs typical).

Figure 2 shows the relationship between  $R_{SET}$  and  $I_{SWlim}$  at different bias voltages,  $V_{IN}$ , when battery voltage,  $V_{BAT}$ , is fixed at 3.6 V.



Peak Current Limit versus ISET Resistance at Various Bias Voltages  $V_{BAT}$  = 3.6 V, Transformer L<sub>P</sub> = 7.5 µH, T<sub>A</sub>=25°C

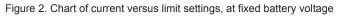




Figure 3 shows the relation between RSET and I<sub>SWlim</sub> at different battery voltages, when bias voltage is fixed at 3.6 V). Note that the spread is inversely proportional to the primary inductance of transformer used.

Fast Charging and Timer Modes

The A8426 achieves fast charging time and high efficiency by operating in discontinuous conduction mode (DCM) with zero-voltage-switching (ZVS). This operation is shown in figure 4.

The IC operates in the Timer mode when beginning to charge a completely discharged photoflash capacitor, usually when the output voltage,  $V_{OUT}$ , is less than approximately 35 V (depending on the inductance of transformer used). Timer mode is a fixed 18 µs offtime control. One advantage of the timer mode is that it limits the initial battery current surge and thus acts as a "soft-start," as shown in figure 5.

As soon as sufficient voltage has built up at the output capacitor, the IC changes into fast-charging mode.

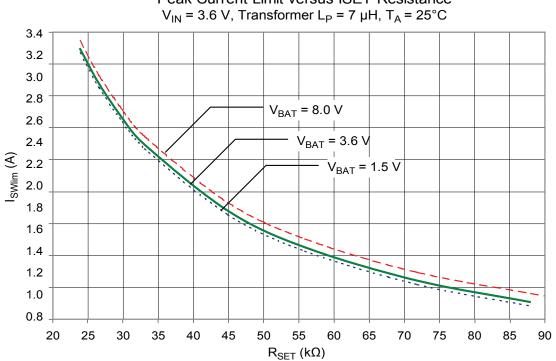
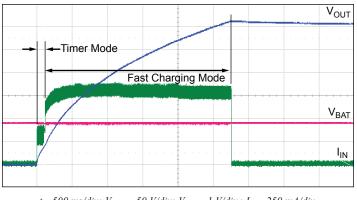




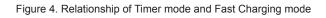
Figure 3. Chart of current versus limit settings, at fixed bias voltage

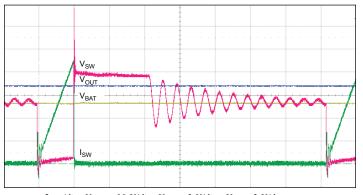


As shown in figure 6, in this mode the next switching cycle starts after the secondary-side current has stopped flowing, and the switch voltage has dropped to a minimum value. A special dV/dt detection circuit is used to allow minimum-voltage switching, even if the SW voltage does not drop to zero volts. This

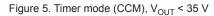


 $\begin{array}{l} t = \! 500 \; ms/div; \; V_{OUT} = \! 50 \; V/div; \; V_{BAT} = \! 1 \; V/div; \; I_{IN} = \! 250 \; mA/div. \\ V_{BAT} = \! 3.6 \; V; \; C_{OUT} = \! 100 \; \mu F/330 \; V; \; R_{SET} = \! 36.5 \; k\Omega \; (I_P \approx 2.2 \; A) \end{array}$ 



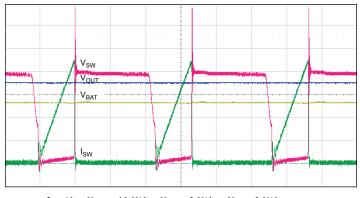


 $\begin{array}{l} t=2 \; \mu s/div; \; V_{OUT}=\!10 \; V/div; \; V_{BAT}=\!3 \; V/div; \; V_{SW}=\!3 \; V/div; \\ I_{SW}=\!500 \; mA/div. \; V_{IN}=3.6 \; V; \; V_{BAT}=\!8.0 \; V; \; R_{SET}=\!36.5 \; k\Omega \; (I_{P}\!\approx\!2.2 \; A); \\ Transformer=\!DCT9.5/5ER, \; L_{P}=7 \; \mu H, \; N=10 \end{array}$ 



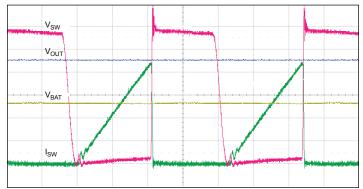
enables fast-charging to start earlier than previously possible, thereby reducing the overall charging time.

When output voltage is high enough (such that  $V_r = V_{OUT} / N$  is greater than  $V_{BAT}$ ), true zero-voltage switching is achieved, which further improves efficiency as well as reducing switching noises (figure 7).



 $\begin{array}{l} t=2 \; \mu s/div; \; V_{OUT}=\!10 \; V/div; \; V_{BAT}=\!3 \; V/div; \; V_{SW}=\!3 \; V/div; \\ I_{SW}=\!500 \; mA/div. \; V_{IN}=3.6 \; V; \; V_{BAT}=\!8.0 \; V; \; R_{SET}=\!36.5 \; k\Omega \; (I_P\!\approx 2.2 \; A); \\ Transformer=\!DCT9.5/5ER, \; L_P\!=7 \; \mu H, \; N=10 \end{array}$ 

Figure 6. Fast-charging mode (DCM),  $V_{OUT}$  > 35 V



 $\begin{array}{l} t = 1 \; \mu s/div; \; V_{OUT} = 20 \; V/div; \; V_{BAT} = 3 \; V/div; \; V_{SW} = 3 \; V/div; \\ I_{SW} = 500 \; mA/div. \; V_{IN} = 3.6 \; V; \; V_{BAT} = 8.0 \; V; \; R_{SET} = 36.5 \; k\Omega \; (I_P \approx 2.2 \; A); \\ Transformer = DCT9.5/5ER, \; L_P = 7 \; \mu H, \; N = 10 \end{array}$ 

Figure 7. Zero-voltage switching



#### **Components Recommendation**

The A8426 uses secondary-side sensing, so the turns ratio, N, of the transformer is not critical for the final target voltage. However, using transformers with higher turns ratios (N=12 or higher) generally results in lower efficiency and longer charge time.

Selection of the flyback transformer should be based on the peak current, according to the following table:

I <sub>Peak</sub> Range	Sup-		L <sub>P</sub>		
(A)	plier	Part Number	(µH)	Ν	
1.0 to 2.0	TDK	LDT565630T-001	6	10.4	
1.0 to 3.2	TDK	DCT9.5/5ER-UxxS003	7.6	10	
1.4 to 3.2	TCE	T-17-160 (TTRN-060)	5.6	10.2	

### **IGBT** Gate Driver Application

The integrated IGBT driver is used to drive an external flash trigger IGBT. A dedicated VDRV pin is provided to supply optimum voltage for the internal IGBT. Separate GSOURCE and GSINK pins allow the user to adjust IGBT turn-on and turn-off rise times. For the Electrical Characteristics table in this document, IGBT drive timing is defined with the GSOURCE and GSINK pins connected together, and supplying a load comprising a 12  $\Omega$  resistor and a 6500 pF capacitor.

### IGBT Gate Driver Interlock

The TRIGGER1 and TRIGGER2 pins are ANDed together inside the IC to control the IGBT gate driver. If only one TRIGGER pin is used, the other TRIG-GER pin must be tied to the VIN pin to ensure that the unused TRIGGER pin is at logic high.

Triggering is disabled (locked) during charging. This is to prevent switching noise from interfering with the IGBT driver. After the CHARGE pin goes high (at the start of a charging cycle), the IC must wait for completion of the charging cycle (DONE goes low) before triggering can be enabled, according to the following chart:

	Cond	Resulting State	
	CHARGE	DONE	IGBT Gate Driver
-	Low	Don't Care	Enabled
	High	High	Disabled
	High	Low	Enabled

The IGBT gate driver is always enabled when the CHARGE pin is low.

It is up to the system-level programming to ensure that a trigger signal is not applied without sufficient voltage at the output capacitor.

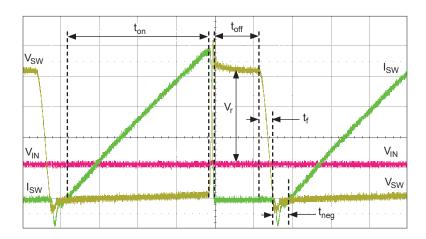
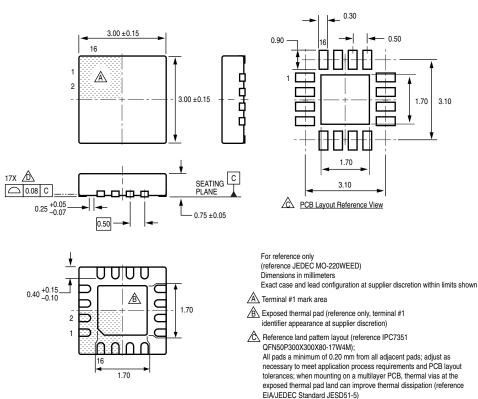


Figure 8. Relationship of  $t_{off}$  and switch output.



### A8426

## High Performance Photoflash Capacitor Charger with IGBT Driver



Package ES, 3 mm x 3 mm 16-Contact TQFN with Exposed Thermal Pad

Coplanarity includes exposed thermal pad and terminals



#### **Revision History**

Revision	Revision Date	Description of Revision
Rev. 1	April 19, 2012	Update Selection Guide, miscellaneous format changes

Copyright ©2008-2012, Allegro MicroSystems, Inc.

Allegro MicroSystems, Inc. reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the performance, reliability, or manufacturability of its products. Before placing an order, the user is cautioned to verify that the information being relied upon is current.

Allegro's products are not to be used in life support devices or systems, if a failure of an Allegro product can reasonably be expected to cause the failure of that life support device or system, or to affect the safety or effectiveness of that device or system.

The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems, Inc. assumes no responsibility for its use; nor for any infringement of patents or other rights of third parties which may result from its use.

For the latest version of this document, visit our website: www.allegromicro.com

